

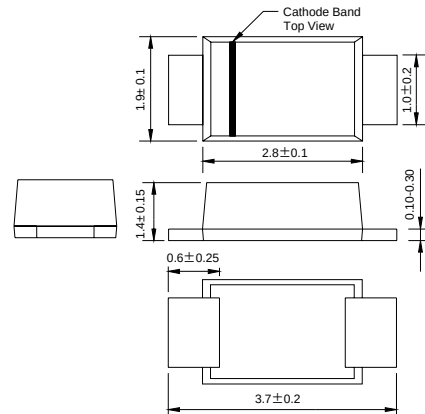
Features

- Schottky Barrier Chip
- Ideally Suited for Automatic Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 20A Peak
- For Use in Low Voltage Application
- Guard Ring Die Construction
- Plastic Case Material has UL Flammability Classification Rating 94V-O

Mechanical Data

- Case: SOD-123, Molded Plastic
- Terminals: Solder Plated, Solderable per MIL-STD-750, Method 2026
- Polarity: Cathode Band or Cathode Notch
- Marking: Type Number
- Weight: 0.01 grams (approx.)
- **Lead Free: For RoHS / Lead Free Version**

SOD - 123FL



Dimensions in millimeters

Maximum Ratings and Electrical Characteristics @T_A=25°C unless otherwise specified

Characteristic	Symbol	DS32W	DS33W	DS34W	DS35W	DS36W	DS38W	DS310W	DS315W	DS320W	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	VRRM VRWM VR	20	30	40	50	60	80	100	150	200	V
RMS Reverse Voltage	VR(RMS)	14	21	28	35	42	56	70	105	140	V
Average Rectified Output Current @T _L = 75°C	Io	3.0									A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	IFSM	80									A
Forward Voltage @IF = 3.0A	VFM	0.55			0.70		0.85		0.95		V
Peak Reverse Current @TA = 25°C At Rated DC Blocking Voltage @TA = 100°C	IRM	0.5 10					0.3 5				mA
Typical Thermal Resistance (Note 1)	RθJL RθJA	28 40									°C/W
Typical Junction Capacitance	Cj	250			160						pF
Operating Temperature Range	Tj	-65 to +125									°C
Storage Temperature Range	TSTG	-65 to +150									°C

Note: 1. Mounted on P.C. Board with 5.0mm² copper pad area.

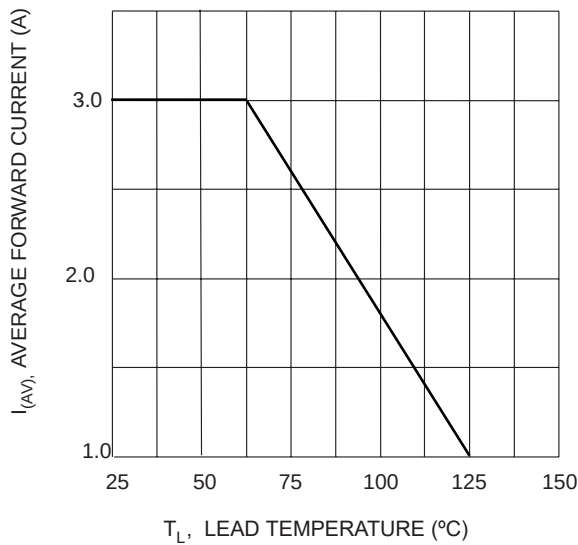


Fig. 1 Forward Current Derating Curve

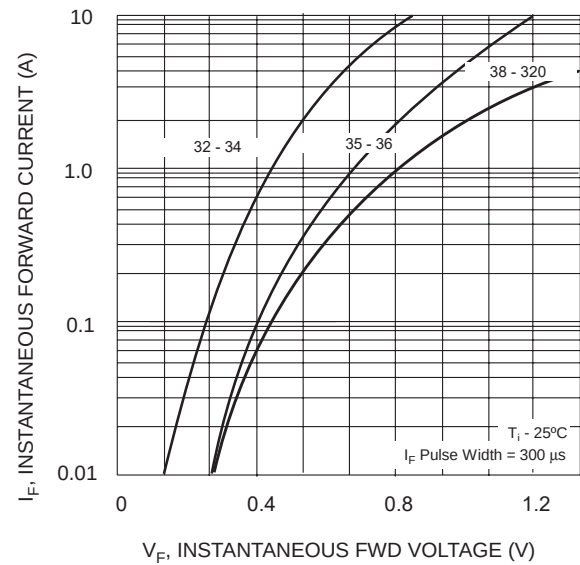


Fig. 2 Typ. Forward Characteristics

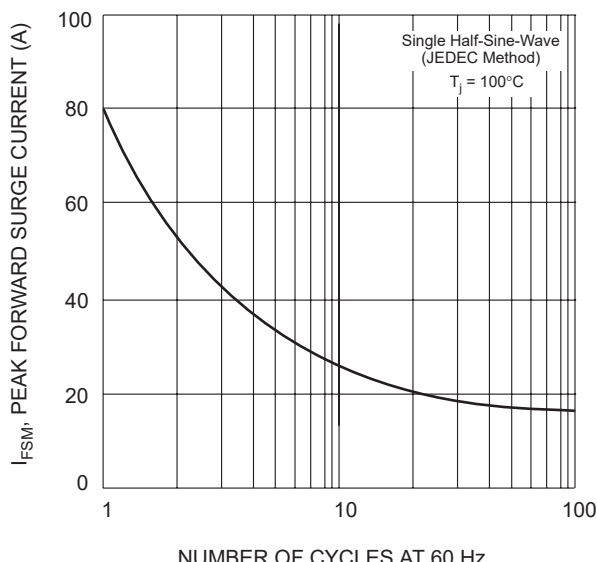


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

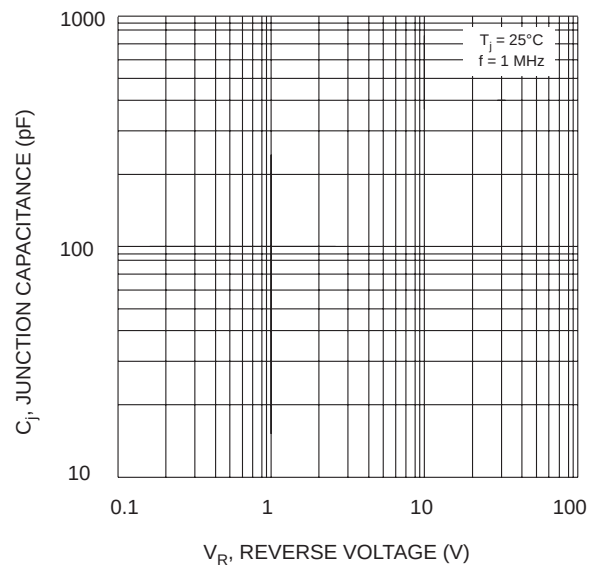


Fig. 4 Typical Junction Capacitance

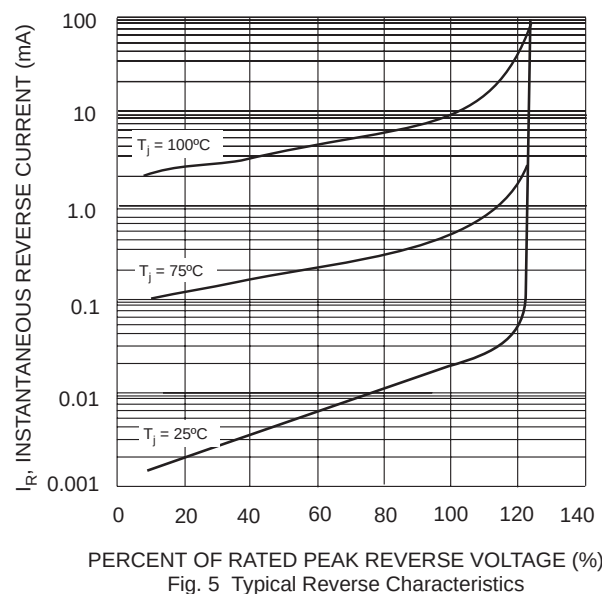


Fig. 5 Typical Reverse Characteristics